# **4MB R4000 Secondary Cache Fast Static RAM Module Set**

Four MCM44256B modules comprise a full 4 MB of secondary cache for the R4000 processor. Each module contains nine MCM6729DWJ fast static RAMs for a cache data size of 256K x 36. The tag portion, dependent on word line size, contains either two MCM6729DWJ or one MCM6726DWJ fast static RAMs. All input signals, except A0 and WE are buffered using 74FBT2827 drivers with series 25  $\Omega$  resistors.

The MCM6729DWJ and MCM6726DWJ are fabricated using high–performance silicon–gate BiCMOS technology. Static design eliminates the need for internal clocks or timing strobes.

All 4MB R4000 supported secondary cache options are available.

- Single 5 V ± 10% Power Supply
- All Inputs and Outputs are TTL Compatible
- Fast Module Access Time: 12/15/17 ns
- Zero Wait-State Operation
- · Unified or Split Secondary Cache is Supported
- Word Line Sizes of 4, 8, 16, and 32 are Available (See Ordering Information for Details)
- Decoupling Capacitors are Used for Each Fast Static RAM and Buffer, Along with Bulk Capacitance for Maximum Noise Immunity
- High Quality Multi–Layer FR4 PWB with Separate Power and Ground Planes

PIN NAMES
A0 - A17
VSS Ground

For proper operation of the device,  $\mathsf{V}_{SS}$  must be connected to ground.

# MCM44256B Series

PIN 80 LEAD	I ASSIGN SIMM –		T P VIEW
VCC	2	1	$V_{SS}$
DQ1	4	3	DQ0
DQ3	6	5	DQ2
DQ5	8	7	DQ4
$V_{SS}$	10	9	DQ6
DQ8	12	11	DQ7
DQ10	14	13	DQ9
DQ12	16	15	DQ11
DQ14	18	17	DQ13
DQ15	20	19	$V_{SS}$
DQ17	22	21	DQ16
DQ19	24	23	DQ18
DQ21	26	25	DQ20
$V_{SS}$	28	27	DQ22
DQ23	30	29	VCC
DQ25	32	31	DQ24
DQ27	34	33	DQ26
DQ29	36	35	DQ28
DQ30	38	37	$V_{SS}$
DQ32	40	39	DQ31
DQ34	42	41	DQ33
VSS	44	43	DQ35
A0	46	45	WE
A2	48	47	A1
A4	50	49	A3
A6	52	51	A5
VCC	54	53	V <sub>SS</sub>
OE	56	55	DCS
A8	58	57	A7
A10	60	59	A9
VSS	62	61	A11
A13	64	63	A12
A15	66	65	A14
A17	68	67	A16
TDQ0	70	69	TCS
TDQ1	72	71	VSS
TDQ3	74	73	TDQ2
TDQ5	76	75	TDQ4
TDQ7	78	77	TDQ6
$V_{SS}$	80	79	VCC

#### **BLOCK DIAGRAM** 256K x 36 CACHE TCS 256K x 4 Ē DCS G OE 74FBT2827 DRIVER Α1 A1 -A2 A2 A3 - A17 A3 – A17 A0 A0 DQ0 - DQ3 DQ0 - DQ35 W WE TDQ0 - TDQ7 TAG OPTIONS: 256K x 4 A0 A1 4 WORD Α2 LINE SIZE A3 - A17 256K x 8 E TAG W G DQ0 - DQ3 128K x 8 8 WORD LINE SIZE Α0 Α1 A2 - A16 128K x 8 E. • TAG W DQ0 - DQ7 (A0 NOT USED) 128K x 8 16 WORD A0 LINE SIZE Α1 A2 – A16 64K x 8 E TAG W G DQ0 - DQ7 (A0, A1 NOT USED) 128K x 8 A0 32 WORD LINE SIZE Α1 <u>A</u>2 – A16 32K x 8 E TAG W G DQ0 - DQ7 (A0, A1, A2 NOT USED)

#### ABSOLUTE MAXIMUM RATINGS (Voltages Referenced to VSS = 0 V)

,	J	00 /	
Rating	Symbol	Value	Unit
Power Supply Voltage	VCC	- 0.5 to 7.0	V
Voltage Relative to VSS	V <sub>in</sub> , V <sub>out</sub>	- 0.5 to V <sub>CC</sub> + 0.5	V
Output Current (per I/O)	l <sub>out</sub>	± 30	mA
Power Dissipation	PD	10	W
Temperature Under Bias	T <sub>bias</sub>	- 10 to + 85	°C
Storage Temperature	T <sub>stg</sub>	- 25 to +125	°C

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPER-ATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

This devices on this module contain circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to these high–impedance circuits.

These BiCMOS memory circuits have been designed to meet the dc and ac specifications shown in the tables, after thermal equilibrium has been established. The module is in a test socket or mounted on a printed circuit board and transverse air flow of at least 500 linear feet per minute is maintained.

#### DC OPERATING CONDITIONS AND CHARACTERISTICS

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, T_A = 0 \text{ to} + 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$ 

## RECOMMENDED OPERATING CONDITIONS (Voltages Referenced to VSS = 0 V)

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage (Operating Voltage Range)	Vcc	4.5	5.0	5.5	V
Input High Voltage (DQ0 – 35, TD <u>Q0 – 7, WE, A0)</u> (A1 – A17, OE, DCS, TCS)	VIH	2.2 2.0	1 1	V <sub>CC</sub> + 0.3 V* V <sub>CC</sub> + 0.3 V*	٧
Input Low Voltage	$V_{IL}$	- 0.5**	_	0.8	V

<sup>\*</sup>  $V_{IH}$  (max) =  $V_{CC}$  + 0.3 V dc;  $V_{IH}$  (max) =  $V_{CC}$  + 2 V ac (pulse width  $\leq$  20 ns).

#### **DC CHARACTERISTICS**

Parameter	Symbol	Min	Тур	Max	Unit
Input Leakage Current (All Inputs, V <sub>in</sub> = 0 to V <sub>CC</sub> )	l <sub>lkg(l)</sub>			± 10	μΑ
Output Leakage Current ( $\overline{G}$ , $\overline{xCS} = V_{IH}$ , $V_{Out} = 0$ to $V_{CC}$ )	Ilkg(O)			± 10	μΑ
AC Supply Current (G, xCS = V <sub>IL</sub> , I <sub>Out</sub> = 0 mA)	ICCA	_	_	1750	mA
Output Low Voltage (I <sub>OL</sub> = + 8 mA)	VOL	_	_	0.4	V
OUtput High Voltage (I <sub>OH</sub> = - 4.0 mA)	Voн	2.4		_	V

NOTE: Good decoupling of the local power supply should always be used.

#### CAPACITANCE (f = 1.0 MHz, dV = 3.0 V, T<sub>A</sub> = 25°C, Periodically Sampled Rather Than 100% Tested)

Parameter	Symbol	Тур	Max	Unit
Input Capacitance (A1 – A17, OE, DCS, TCS)	C <sub>in</sub> C <sub>in</sub>	_ _	110 10	pF pF
Input/Output Capacitance	C <sub>out</sub>	_	10	pF

MOTOROLA FAST SRAM MCM44256B SERIES

<sup>\*\*</sup>  $V_{IL}$  (min) = -3.0 V ac (pulse width  $\leq 20$  ns).

## **AC OPERATING CONDITIONS AND CHARACTERISTICS**

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, T_A = 0 \text{ to} + 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$ 

Input Timing Measurement Reference Level 1.5 V	Output Timing Measurement Reference Level 1.5 V
Input Pulse Levels 0 to 3.0 V	Output Load See Figure 1
Input Rise/Fall Time 1 V/ns (20% to 80%)	

## READ CYCLE (See Notes 1 and 2)

		-1	12	-1	15	-1	17		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Address Access Time	<sup>t</sup> AVQV	_	12	_	15	_	17	ns	
A0 Access Time	tA0AQV	_	10	_	12	_	14	ns	
Data/Tag Enable Access Time	<sup>t</sup> ELQV	_	12	_	15	_	17	ns	
Output Enable Access Time	tGLQV	_	9	_	10	_	11	ns	
Output Hold from Address Change	t <sub>AXQX</sub>	4	_	4	_	4	_	ns	
Output Hold from A0 Change	tA0XQX	4	_	4	_	4	_	ns	
Data/Tag Enable Low to Output Active	<sup>t</sup> ELQX	2	_	2	_	2	_	ns	3, 4
Data/Tag Enable High to Output High–Z	<sup>t</sup> EHQZ	1	9	1	10	1	11	ns	3, 4
Output Enable Low to Output Active	<sup>t</sup> GLQX	1	_	1	_	1		ns	3, 4
Output Enable High to Output High–Z	<sup>t</sup> GHQZ	1	9	1	10	1	11	ns	3, 4

# NOTES:

- 1. WE is high for read cycle.
- 2. Enable timings are the same for both DCS and TCS.
- 3. Transition is measured 200 mV from steady-state voltage.
- 4. This parameter is sampled and not 100% tested.

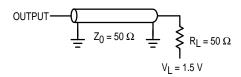
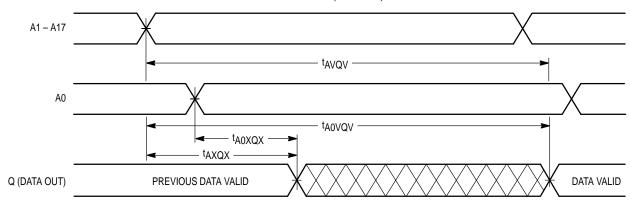


Figure 1. AC Test Load

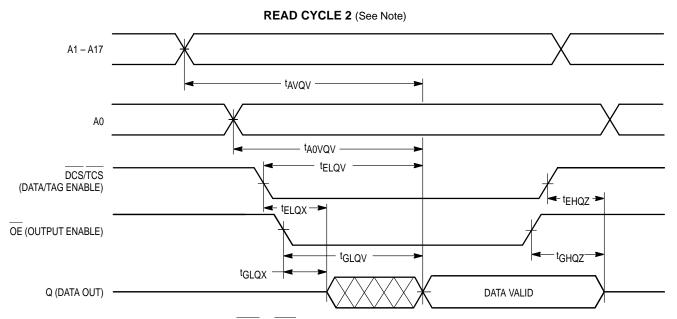
# **TIMING LIMITS**

The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time. On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.

# READ CYCLE 1 (See Note)



NOTE: Module is continuously selected ( $\overline{DCS}$  or  $\overline{TCS}$  =  $V_{IL}$ ,  $\overline{OE}$  =  $V_{IL}$ ).



NOTE: Address valid prior to or coincident with  $\overline{\rm DCS}$  or  $\overline{\rm TCS}$  going low.

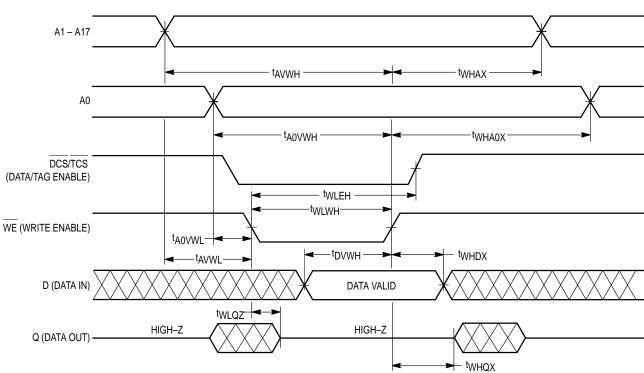
WRITE CYCLE 1 (WE Controlled, See Notes 1 and 2)

			-12		-15		-17		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Address Setup Time	tAVWL	5	_	5		5	_	ns	
A0 Setup Time	<sup>t</sup> A0VWL	0	_	0	_	0	_	ns	
Address Valid to End of Write	<sup>t</sup> AVWH	12	_	15	_	17	_	ns	
A0 Valid to End of Write	tA0VWH	10	_	12	_	14	_	ns	
Write Pulse Width	tWLWH, tWLEH	7	_	10	_	12	_	ns	
Data Valid to End of Write	tDVWH	6	_	7	_	8	_	ns	
Data Hold Time	tWHDX	0	_	0	_	0	_	ns	
Write Low to Data High-Z	tWLQZ	0	4	0	5	0	6	ns	3, 4
Write High to Output Active	tWHQX	3	_	3	_	3	_	ns	3, 4
Write Recovery Time	tWHAX	0	_	0	_	0	_	ns	
Write Recovery Time — A0	tWHA0X	0	_	0		0	_	ns	

## NOTES:

- 1. A write occurs during the overlap of D<u>CS or TCS low</u> and WE low.
- Enable timings are the same for both DCS and TCS.
   Transition is measured 200 mV from steady–state voltage.
- 4. This parameter is sampled and not 100% tested.

# **WRITE CYCLE 1**



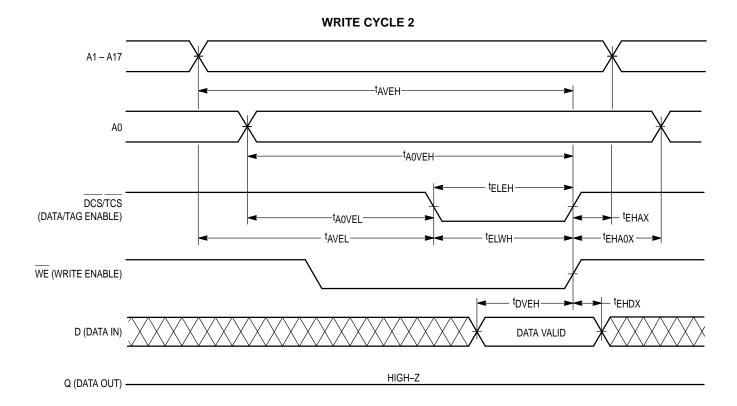
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 $\textbf{WRITE CYCLE 2} \ (\overline{\text{DCS}} \ \text{or} \ \overline{\text{TCS}} \ \text{Controlled, See} \ \text{Notes 1 and 2)}$ 

		-12		-15		-17			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Address Setup Time	<sup>t</sup> AVEL	0	_	0	_	0	_	ns	
A0 Setup Time	<sup>t</sup> A0VEL	0	_	0	_	0	_	ns	
Address Valid to End of Write	<sup>t</sup> AVEH	12	_	15	_	17	_	ns	
A0 Valid to End of Write	<sup>t</sup> A0VEH	10	_	12	_	14	_	ns	
Data/Tag Enable to End of Write	<sup>t</sup> ELEH, <sup>t</sup> ELWH	12	_	15	_	17	_	ns	
Data Valid to End of Write	<sup>t</sup> DVEH	6	_	7	_	8	_	ns	
Data Hold Time	<sup>t</sup> EHDX	5	_	5	_	5	_	ns	
Write Recovery Time	<sup>t</sup> EHAX	5	_	5	_	5	_	ns	
Write Recovery Time — A0	tEHA0X	5	_	5	_	5	_	ns	

#### NOTES:

- A write occurs during the overlap of DCS or TCS low and WE low.
   Enable timings are the same for both DCS and TCS.



MOTOROLA FAST SRAM MCM44256B SERIES

# ORDERING INFORMATION (Order by Full Part Number)

MCM	44X256B	XX	XX

	 - :X-00B	<del>///\</del>	<del>/\/\</del>	
Motorola Memory Prefix				Speed (12 = 12 ns, 15 = 15 ns, 17 = 17 ns
Part Number				Package (SG = Gold Pad SIMM)

Part Number	Unified/Split	Word Line Size	TAG Depth
MCM44A256B	Unified/Split	4	256K
MCM44B256B	Unified/Split	8	128K
MCM44C256B	Unified/Split	16	64K
MCM44D256B	Unified/Split	32	32K

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